Silicon N-Channel Dual Gate MOS FET



ADE-208-388 1st. Edition

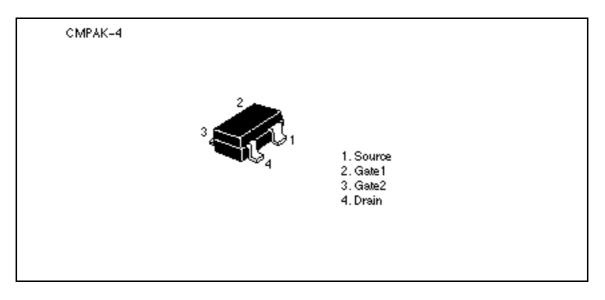
Application

UHF RF amplifier

Features

- Low noise figure. NF = 2.0 dB Typ. at f = 900 MHz
- Capable of low voltage operation

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DS}	12	V
Gate 1 to source voltage	V _{G1S}	±8	V
Gate 2 to source voltage	V _{G2S}	±8	V
Drain current	I _D	25	mA
Channel power dissipation	Pch	100	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

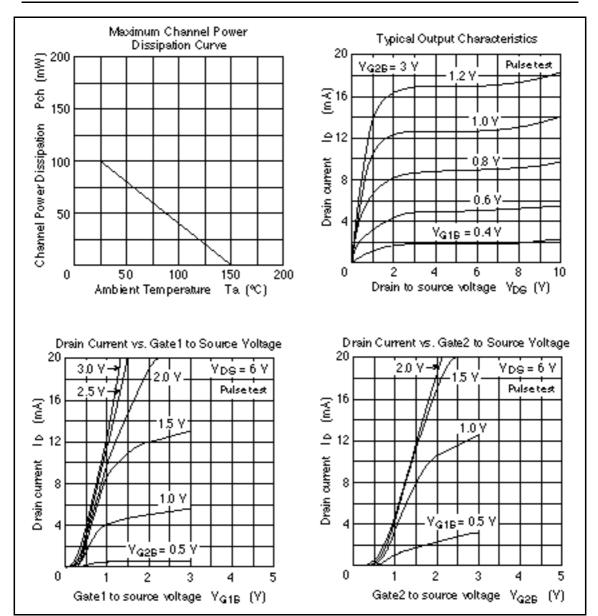
Attention: This device is very sensitive to electro static discharge.

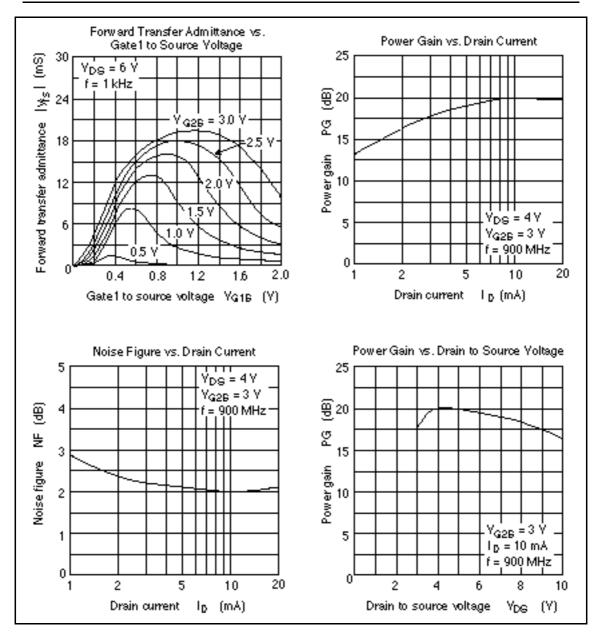
It is recommended to adopt appropriate cautions when handling this transistor.

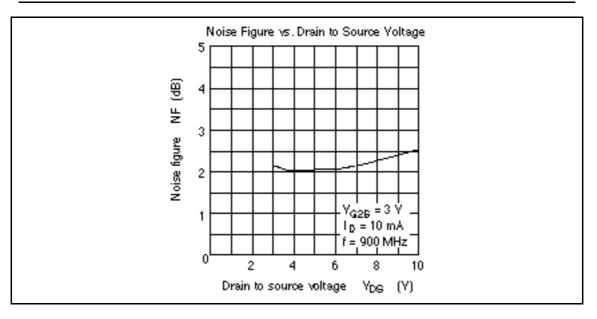
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSX}}$	12	_	_	V	$I_{_{D}}$ = 200 μA , $V_{_{G1S}}$ = –3 V, $V_{_{G2S}}$ = –3 V
Gate 1 to source breakdown voltage	$V_{(\text{BR})\text{G1SS}}$	±8	_	_	V	$I_{G1} = \pm 10 \ \mu A, \ V_{G2S} = V_{DS} = 0$
Gate 2 to source breakdown voltage	$V_{(BR)G2SS}$	±8	_	_	V	$I_{G2} = \pm 10 \ \mu A$, $V_{G1S} = V_{DS} = 0$
Gate 1 cutoff current	I_{G1SS}	_	_	±100	nA	$V_{G1S} = \pm 6 V, V_{G2S} = V_{DS} = 0$
Gate 2 cutoff current	I_{G2SS}	_	_	±100	nA	$V_{G2S} = \pm 6 V, V_{G1S} = V_{DS} = 0$
Drain current	I _{DS(on)}	0.5	_	10	mA	$V_{\rm DS}$ = 6 V, $V_{\rm G1S}$ = 0.5V, $V_{\rm G2S}$ = 3 V
Gate 1 to source cutoff voltage	$V_{\text{G1S(off)}}$	-0.5	_	+0.5	V	$V_{\rm DS}$ = 10 V, $V_{\rm G2S}$ = 3V, $I_{\rm D}$ = 100 µA
Gate 2 to source cutoff voltage	$V_{\text{G2S(off)}}$	0	_	+1.0	V	$V_{\rm DS}$ = 10 V, $V_{\rm G1S}$ = 3V, $I_{\rm D}$ = 100 µA
Forward transfer admittance	y _{fs}	16	20.8	_	mS	$V_{DS} = 6 V, V_{G2S} = 3V,$ $I_{D} = 10 mA, f = 1 kHz$
Input capacitance	Ciss	1.2	1.5	2.2	pF	$V_{DS} = 6 V, V_{G2S} = 3V,$ $I_{D} = 10 mA, f = 1 MHz$
Output capacitance	Coss	0.6	0.9	1.2	pF	_
Reverse transfer capacitance	Crss	—	0.01	0.03	pF	_
Power gain	PG	16	19.5	_	dB	$V_{DS} = 4 V, V_{G2S} = 3V,$ $I_{D} = 10 mA, f = 900 MHz$
Noise figure	NF	_	2.0	3	dB	

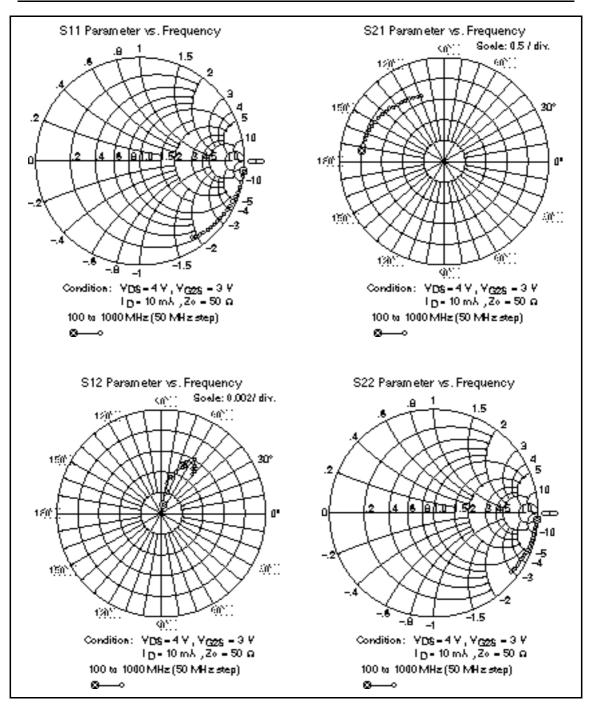
Electrical Characteristics (Ta = 25°C)

Note: Marking is "ZQ-"









Freq.	S11		S21		S12		S22	
(MHz)	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.
100	0.999	-6.1	1.98	172.2	0.00094	79.2	0.989	-4.2
150	0.998	-9.1	1.97	168.4	0.00189	80.4	0.987	-6.1
200	0.992	-11.9	1.96	165.0	0.00230	79.5	0.986	-7.9
250	0.988	-14.8	1.96	161.0	0.00286	79.9	0.984	-9.8
300	0.985	-17.9	1.94	157.1	0.00364	75.2	0.981	-11.5
350	0.976	-20.6	1.92	153.7	0.00353	71.8	0.978	-13.4
400	0.971	-23.2	1.91	149.9	0.00419	70.7	0.975	-15.2
450	0.964	-26.3	1.88	146.8	0.00495	65.5	0.972	-17.2
500	0.961	-29.1	1.87	142.8	0.00509	62.7	0.968	-19.1
550	0.951	-32.2	1.86	139.4	0.00530	66.6	0.963	-20.8
600	0.949	-35.0	1.86	136.1	0.00550	63.8	0.960	-22.8
650	0.935	-37.6	1.81	132.9	0.00601	58.2	0.956	-24.5
700	0.933	-40.5	1.78	129.4	0.00582	60.6	0.950	-26.3
750	0.923	-42.9	1.77	125.7	0.00572	58.5	0.945	-28.0
800	0.916	-45.8	1.75	122.6	0.00553	56.3	0.941	-29.9
850	0.908	-49.0	1.72	119.1	0.00514	56.3	0.936	-31.7
900	0.900	-51.2	1.70	115.8	0.00543	52.9	0.930	-33.4
950	0.890	-54.0	1.67	112.6	0.00506	52.4	0.924	-35.2
1000	0.876	-56.4	1.65	109.3	0.00469	51.9	0.919	-37.0

S Parameter ($V_{DS} = 4 V$, $V_{G2S} = 3 V$, $I_D = 10 mA$, $Z_O = 50$)

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